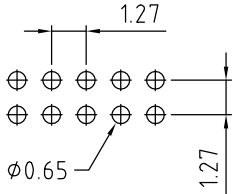
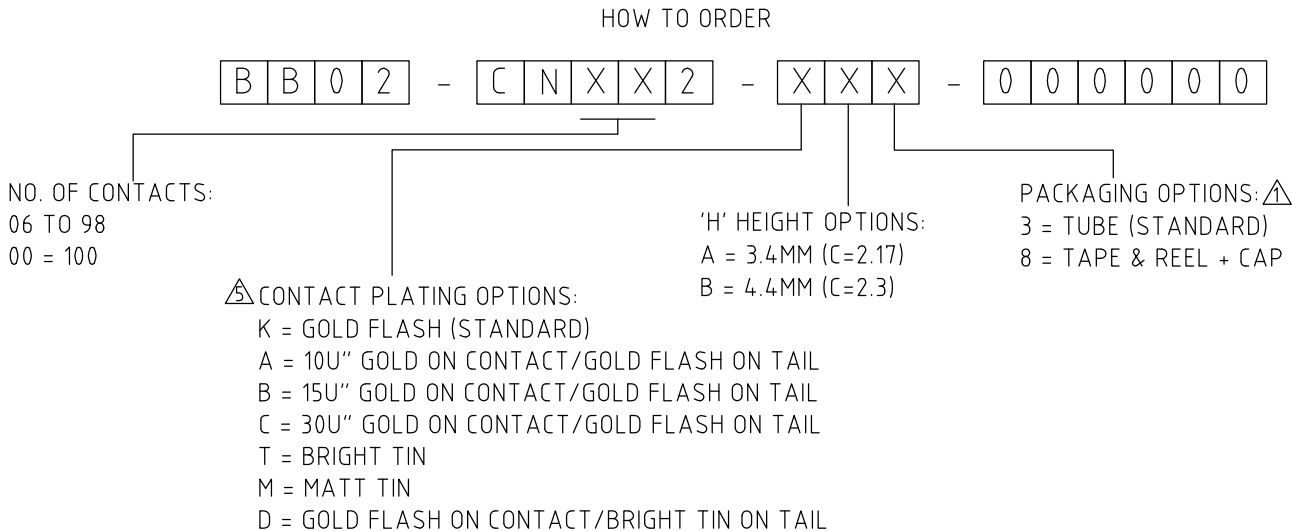


BB02-CN		CUSTOMER PRODUCT SPECIFICATION SHEET				RoHS Compliant	
BB02-CN :- 1.27mm x 1.27mm (0.05" x 0.05") SOCKET, THROUGH HOLE, DUAL ROW, STRAIGHT - 06 to 100 CONTACTS							
SPECIFICATIONS							
CURRENT RATING		1 AMP					
INSULATOR RESISTANCE		1000 MEGOHMS MIN.					
DIELECTRIC WITHSTANDING		300 V AC/DC					
OPERATING TEMPERATURE		-40°C TO +105°C					
CONTACT MATERIAL		PHOSPHOR BRONZE					
INSULATOR MATERIAL		THERMOLPASTIC, UL 94V-0					
		STANDARD: LCP					
PLATING		GOLD, TIN, OR SELECTIVE OVER 30~50U" NICKEL					
SOLDERABILITY		IR REFLOW: 280°C FOR 10 SEC					
		WAVE: 250°C FOR 5-10 SEC					
		MANUAL SOLDER: 380°C FOR 3-5 SEC					
NOTES:							
1. RECOMMENDED MATING PIN LENGTH: 3.0MM 							
MATES WITH :- BB02-BC BB02-BS BB02-7B							
BB02-BD BB02-BY							
BB02-BE BB02-BZ							
BB02-BK BB02-NE							
BB02-BP BB02-NN							
NOTE: BE, BY, BZ, NN AND 7B WILL ACCEPT 4.40MM HIGH SOCKET.							
							
RECOMMENDED PC BOARD HOLE LAYOUT (TOLERANCE: ±0.05)		HOW TO ORDER					
		NO. OF CONTACTS: 06 TO 98 00 = 100					
		CONTACT PLATING OPTIONS: K = GOLD FLASH (STANDARD) A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL C = 30U" GOLD ON CONTACT/GOLD FLASH ON TAIL T = BRIGHT TIN M = MATT TIN D = GOLD FLASH ON CONTACT/BRIGHT TIN ON TAIL					
		'H' HEIGHT OPTIONS: A = 3.4MM (C=2.17) B = 4.4MM (C=2.3)					
		PACKAGING OPTIONS:  3 = TUBE (STANDARD) 8 = TAPE & REEL + CAP					